

MoO₃ and WO₃ based thin film conductimetric sensors for automotive applications

A. K. PRASAD, P. I. GOUMA

Department of Materials Science and Eng., SUNY at Stony Brook, NY 11794, USA

E-mail: k.arunprasad@lycos.com; akapalee@ic.sunysb.edu

Un-doped semiconducting oxides suitable for automotive gas sensor applications have been studied in this work. Thin films of MoO₃ and WO₃ were fabricated by ion beam deposition on alumina substrates with gold interdigitated electrodes. The process pressure inside the deposition chamber was 1.6×10^{-4} Torr. The oxygen to argon ratio in the secondary plasma was maintained at 5:5 sccm. A stabilization heat treatment of 500°C for 8 h was performed for each set of films that produced nanocrystalline structures. Gas sensing tests were carried out at 450°C with nitrogen dioxide/ammonia with synthetic air background similar to those realized in diesel automotive exhausts. XRD and electron microscopy studies were performed to understand the microstructure of the thin films following the sensing tests. The MoO₃ films were selective to ammonia whereas the WO₃ films showed high sensitivity towards NO₂ with respect to NH₃. An attempt is made to correlate the structural characteristics to the sensing behavior of the materials.

© 2003 Kluwer Academic Publishers

1. Introduction

The automotive industry is using chemical sensors for emission control and environmental protection. Selectivity to a particular gas has been the key issue of chemical sensor technology that is still lacking. The state of the art in achieving gas selectivity involves the use of metallic or oxide additions as secondary components in sensing elements or the use of multiple sensor arrays. The former approach is only partially effective as aging effects associated with long term use of these detectors allow for the formation of solid solutions and the loss of any gas specificity. The latter approach uses multiple sensors and complex signal processing methods to discriminate between responses to different gases. There is a need for selective chemical sensors for high temperature and harsh environment applications, such as for monitoring emissions from combustion processes. There are several challenges associated with the development of sensor technology for monitoring combustion processes. These include high temperatures, presence of reducing and oxidizing gases, organic vapors (VOCs), high flow rates, etc.

Recently the application of ammonia sensors and NO₂ sensors in selective catalytic reduction (SCR) systems has gained importance [1, 2]. SCR systems are employed in the exhaust system of commercial vehicles, combustion systems in power plants and in industrial boilers to monitor the emissions of NO₂ and NO. These gases are harmful by-products of combustion processes. In a SCR converter, ammonia serves as a reducing agent for nitrogen oxides converting them into environmentally safe nitrogen and water vapor. An ammonia sensor is required to calculate the amount of un-reacted and excess ammonia, which is

fed into the inlet stream. This necessitates the development of a selective ammonia sensor capable of detecting small quantities of ammonia in the presence of interfering gases, such as NO_x, CO, and hydrocarbons.

Semiconductor metal-oxide-based gas sensors have been utilized in gas detection in automobiles. This work focuses on two metal oxide systems—Molybdenum oxide, which possesses excellent catalytic, electrochromic and gas sensing properties, and tungsten oxide which has been used to detect various gases due to its excellent semiconducting properties. Mutschall *et al.* [3] first reported the suitability of MoO₃ as a potential material for ammonia sensing. Further studies on MoO₃ based gas sensors were carried out by various research groups [4–6]. Obermeier's group at the University of Berlin studied MoO₃ as gas sensor by depositing the material using RF sputtering on oxidized silicon substrates containing a 30 nm Al₂O₃ adhesion layer and interdigitated Pt electrodes on top. The MoO₃ films had whisker like grain structures and large grain size. They studied the sensing response of MoO₃ to various gases, including CO, CH₄, SO₂, NO₂ and NH₃ in the temperature range of 250°C and 475°C, revealing that MoO₃ was twice as sensitive to NH₃ than to NO₂ and H₂ at 425°C and that the gas sensitivity dropped with decreasing film thickness (<300 nm). Multilayer sputter processing of MoO₃ by the same research group resulted in improved H₂ sensing properties and low cross-sensitivity towards NH₃ [7]. The same group discussed the enhancement of sensitivity and selectivity to NH₃ following the addition of Ti overlayers to MoO₃, (and to H₂, by adding V₂O₅ to MoO₃ [5]). However, Guidi *et al.* [8] reported sensitivity towards CO for Ti additions to MoO₃.

CHEMICAL SENSORS

Shaver reported the first WO_3 gas sensor for the detection of hydrogen [9]. Since then there has been various reports on WO_3 sensors for detecting NO_2 and NH_3 [8, 10–16] and other gases such as ozone and H_2S [17–19]. There has been numerous reports on WO_3 sensors for NO_x detection [2, 11–14, 20]. Chung *et al.* [20] discuss the sensing properties for thick film WO_3 sensors which are sensitive to NO_2 at 100°C . These films showed a very weak response to NO_2 above 250°C and the response was found to be *p*-type at higher temperatures ($>250^\circ\text{C}$). Marquis *et al.* [2] discuss the fabrication of sensor arrays for selective detection of NO_2 and NH_3 . These films were found to operate at optimum temperature of 300°C and 350°C for selective detection of NO_2 and NH_3 respectively. During processing, the substrates were kept at 200°C or higher. Dopants were used to achieve selectivity. Sberveglieri *et al.* [12] reported the sensing properties of sputter deposited WO_3 thin films deposited at 350°C . The films showed good response to NO_x at 400°C . They report the presence of triclinic phase being stabilized for the undoped material. Penza *et al.* [11] have reported the presence of tetragonal WO_3 films being sensitive to NO_2 at 250°C .

This paper focuses on un-doped MoO_3 and WO_3 thin films prepared by ion beam deposition. There is strong evidence available in the field of catalysis that MoO_3 exhibits *structure sensitivity* in some catalytic processes, such as the NO reduction with NH_3 . That is, the catalytic activity and selectivity of this oxide correlate with the grain morphology as well as with the crystallographic orientation of the surface exposed to the gaseous species. Therefore, it is expected that such structure sensitivity may affect the response of MoO_3 (and the related system WO_3) with regard to the gas sensing processes, particularly towards ammonia and nitrogen dioxide at temperatures similar to those realized in automotive exhausts.

2. Experimental

Thin films of MoO_3 were reactively ion beam-deposited onto alumina substrates in a dual ion beam deposition (IBD) system. A 12" diameter molybdenum tar-

get was utilized to sputter Mo using a filamentless radio-frequency inductively coupled plasma (RFICP) primary source, with the film partially oxidized during growth using a RFICP assist source directed at the substrate which is held at room temperature and water cooled. The ratio of oxygen to argon in the secondary plasma was maintained at 5:5 sccm. The overall process pressure was 1.6×10^{-4} Torr. A more detailed description of the deposition chamber is given elsewhere [21]. The alumina substrates were pre-patterned with $200 \mu\text{m}$ thick interdigitated Au electrodes. Deposition was carried out for half an hour. Following deposition, the films were annealed at 500°C in air for 8 h to complete the oxidation to MoO_3 . A similar procedure was adopted for preparing WO_3 films using tungsten target (6" diameter).

Sensing tests were carried out with nitrogen dioxide and ammonia gases with synthetic air (10% oxygen and balance nitrogen) in the background. The gases were controlled using 1479 MKS mass flow controllers. The combined flow rate of the gases was maintained at 1000 sccm. A Lindberg/Blue tube furnace is used for programmed heating and the resistance of the sensor monitored using Agilent 34401 digital multimeter. The sensor response is plotted as change in resistance versus time, with varying gas concentration.

Characterization of the films was carried out using Philips CM12 TEM with LaB_6 cathode excited at 120 keV and XRD. The films were analyzed after sensing tests.

3. Results

3.1. Tungsten trioxide

3.1.1. Sensing tests

The response of the IBD WO_3 to ammonia and NO_2 at 450°C is as shown in Figs 1 and 2 respectively. As is evident from the graphs, WO_3 is highly sensitive to NO_2 even at the low concentration of 1 ppm. The response and recovery times are 10 s and 25–50 min respectively. The adsorption of NO_2 on the surface of the WO_3 and possible slow desorption time may be responsible for the prolonged recovery time. Gas adsorption studies are

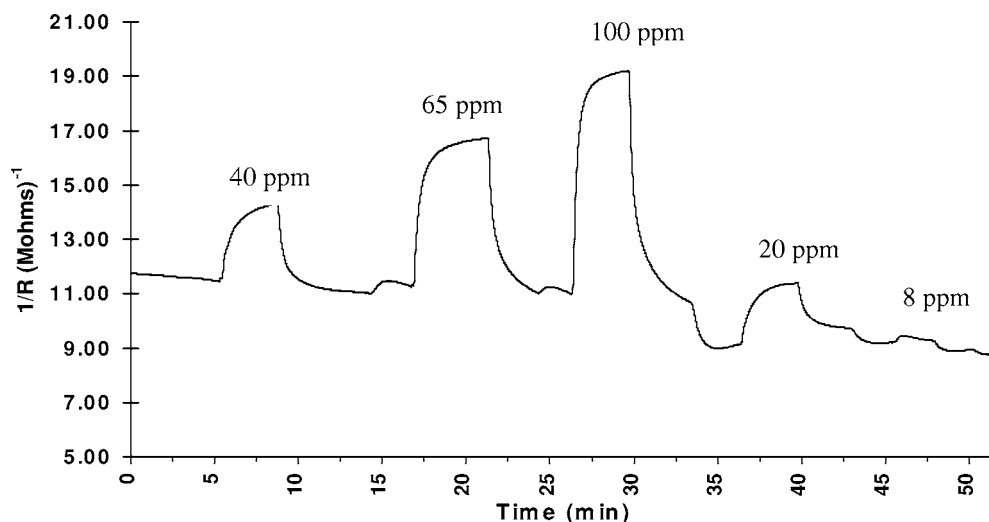


Figure 1 Response of IBD WO_3 to ammonia (100 ppm to 8 ppm).

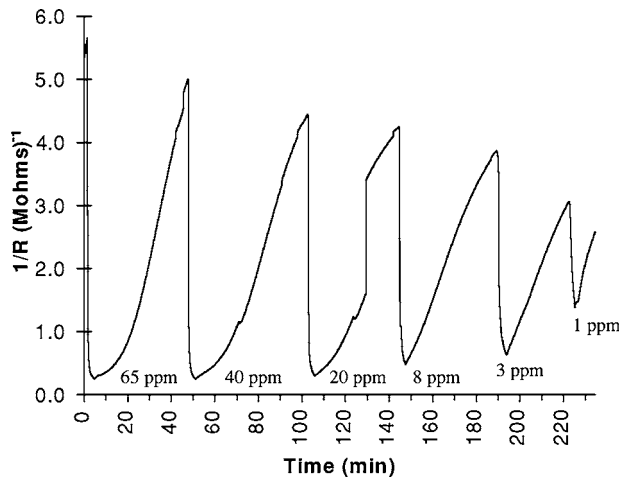


Figure 2 Response of IBD WO₃ to NO₂ (65 ppm down to 1 ppm).

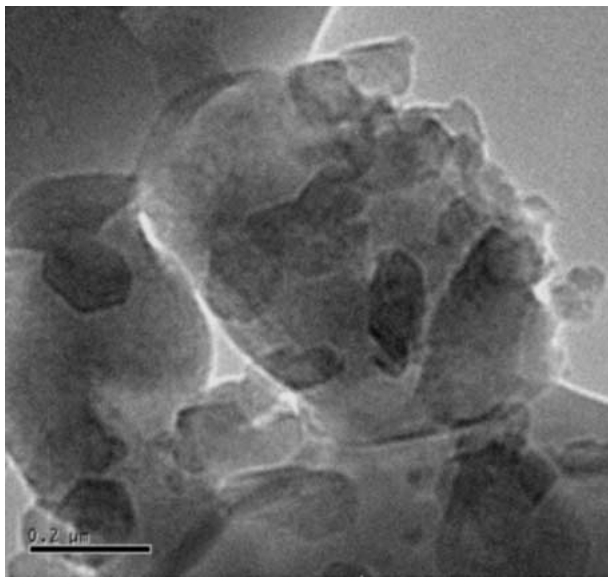


Figure 3 TEM image of IBD WO₃.

required to clarify this issue. The response to ammonia, though fast (10–15 s), is negligible when compared to NO₂. Taking the sensitivity into account (10 times increase in resistance for NO₂ as opposed to within 0.75 times for NH₃), WO₃ films prepared by IBD is relatively selective towards NO₂ over NH₃.

3.1.2. Characterization

Fig. 3 shows the transmission electron micrograph of ion beam deposited WO₃ after sensing experiments. It can be observed that the film is composed of tiny grains of 50 nm. XRD studies of the films after sensing revealed the presence of orthorhombic phase (JCPDS 71-0131—Space Group: Pmnb 62, a: 7.341 Å, b: 7.57 Å, c: 7.754 Å) (Fig. 4).

3.2. Molybdenum trioxide

3.2.1. Sensing tests

The response of ion beam deposited MoO₃ to ammonia and nitrogen dioxide is shown in Figs 5 and 6 respectively. As seen from the graphs, ion beam deposited MoO₃ films are selective to ammonia over nitrogen dioxide. In Fig. 5, the conductance is plotted against time for various concentrations of ammonia. The concentration of ammonia is varied from around 490 ppm down to 10 ppm with a background gas containing 10% oxygen and the remainder nitrogen. Ammonia being a reducing gas, the conductance of the film increases when ammonia is passed over it and is proportional to the concentration of ammonia. The response time is rapid (a few seconds) and the recovery time is also fast (in the order of 2–3 min).

The film is then subjected to varying NO₂ concentrations from 490 ppm down to 10 ppm. It is found that there is negligible change in conductance upon NO₂ exposure.

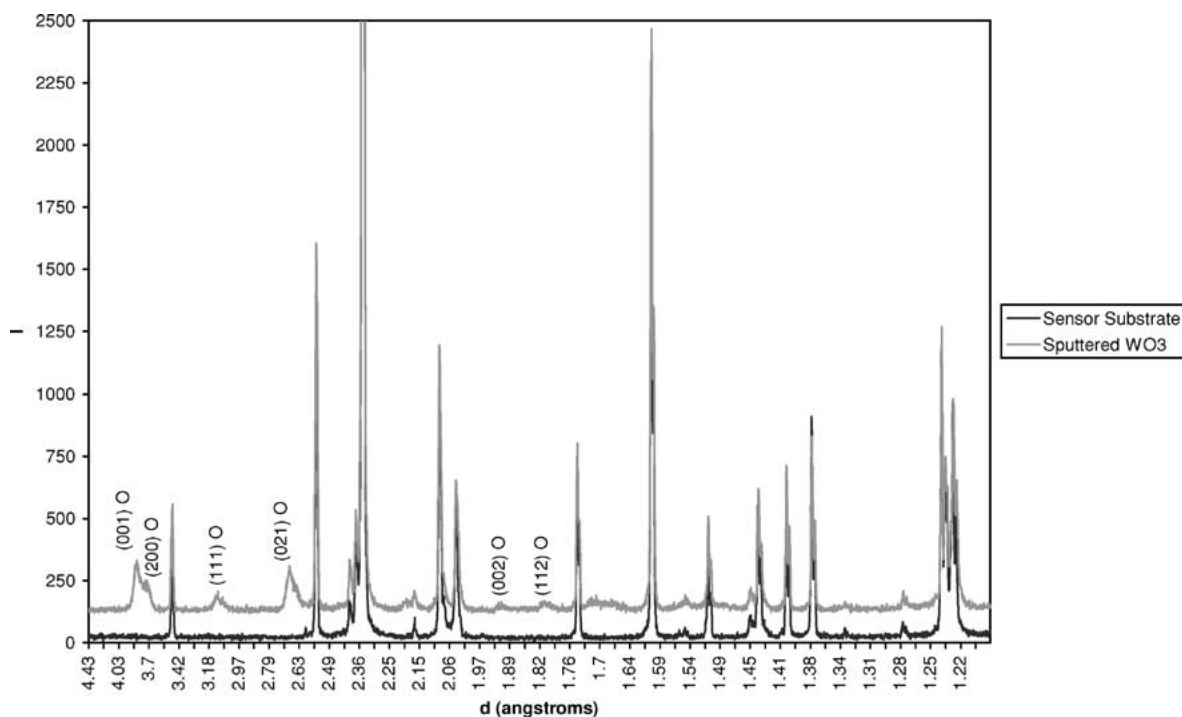


Figure 4 d vs. I graph for ion beam deposited WO₃ after sensing tests.

CHEMICAL SENSORS

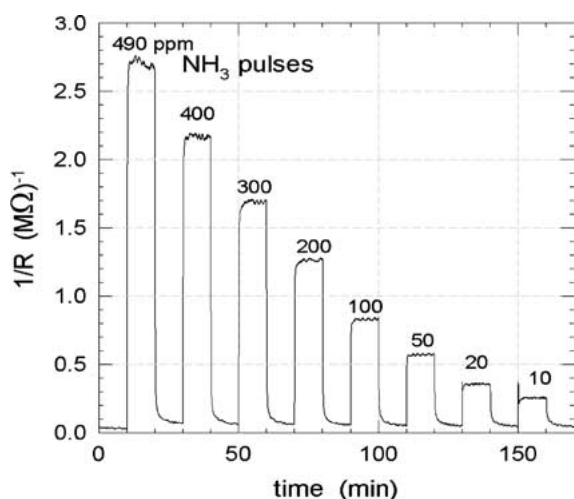


Figure 5 Response of ion beam deposited MoO₃ films to ammonia at 450°C.

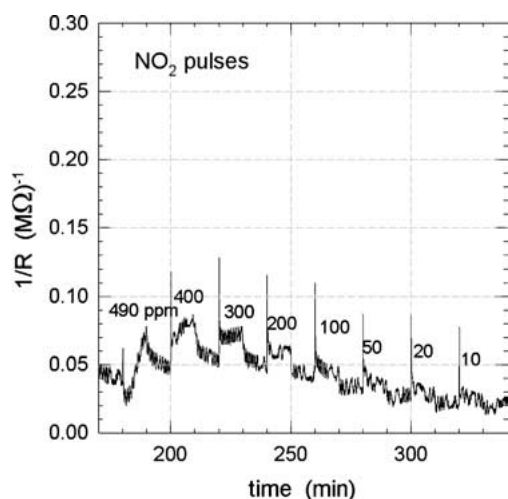


Figure 6 Response of ion beam deposited MoO₃ films to nitrogen dioxide at 450°C.

3.2.2. Characterization

Fig. 7 shows a bright field transmission electron micrograph showing the grain structure of a sputtered and heat-treated MoO₃ film. The average grain size is approximately 60 nm. XRD characterization performed on the film after sensing revealed the presence of orthorhombic phase (JCPDS 35-0609—Space Group: Pbnm 62, a: 3.9630 Å, b: 13.856 Å, c: 3.6964 Å) as shown in Fig. 8.

4. Discussion

The simple nature of the sensing mechanism of resistive sensors often results in a given oxide system being sensitive to more than one type of gases, which causes undesirable gas interference effects to the sensing behavior of this system.

This paper has focused on the undoped material and has addressed the importance of the polymorph selection for gas sensing. Excellent sensitivity and selectivity to ammonia were obtained when the orthorhombic MoO₃ phase was used for sensing. Orthorhombic MoO₃ crystallizes in a unique 2D layered structure that is built up of double chains of edge-sharing [MoO₆] octahedral connected through vertices.

Tungsten trioxide films prepared in our case were stabilized in orthorhombic phase and were found sensitive to NO₂ over NH₃. We have shown that there is a 10 time decrease in conductance when the films are exposed to NO₂ whereas there is only a 0.75 times increase on exposure to ammonia. We also relate the polymorphic dissimilarities between orthorhombic MoO₃ and orthorhombic WO₃. The crystal structure of WO₃ is a distortion of rhenium oxide cubic structure in which tungsten atoms are located in cube corners and the oxygen atoms are located on the cube edges [22]. The

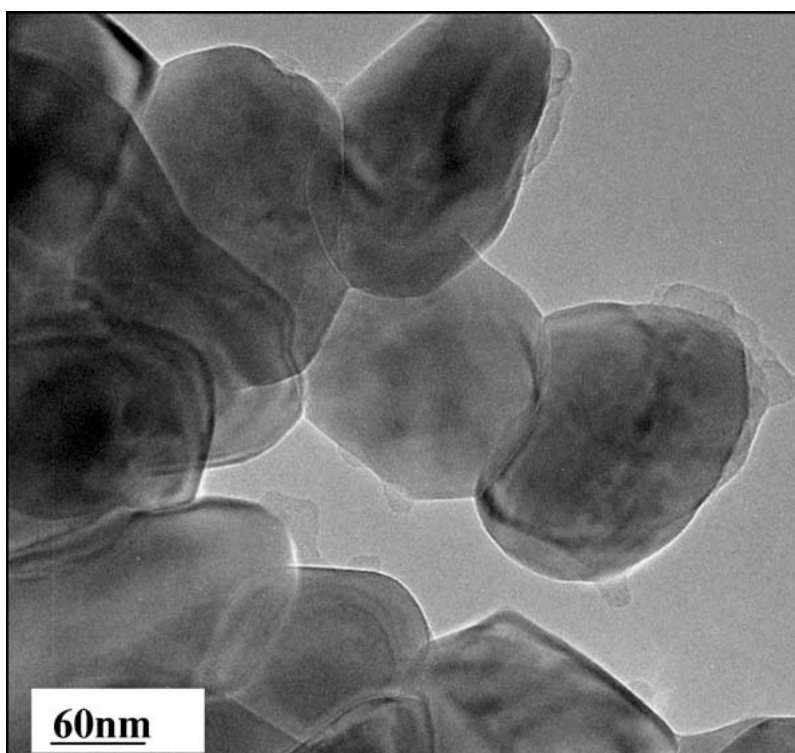


Figure 7 Microstructure of MoO₃ thin films used for sensing.

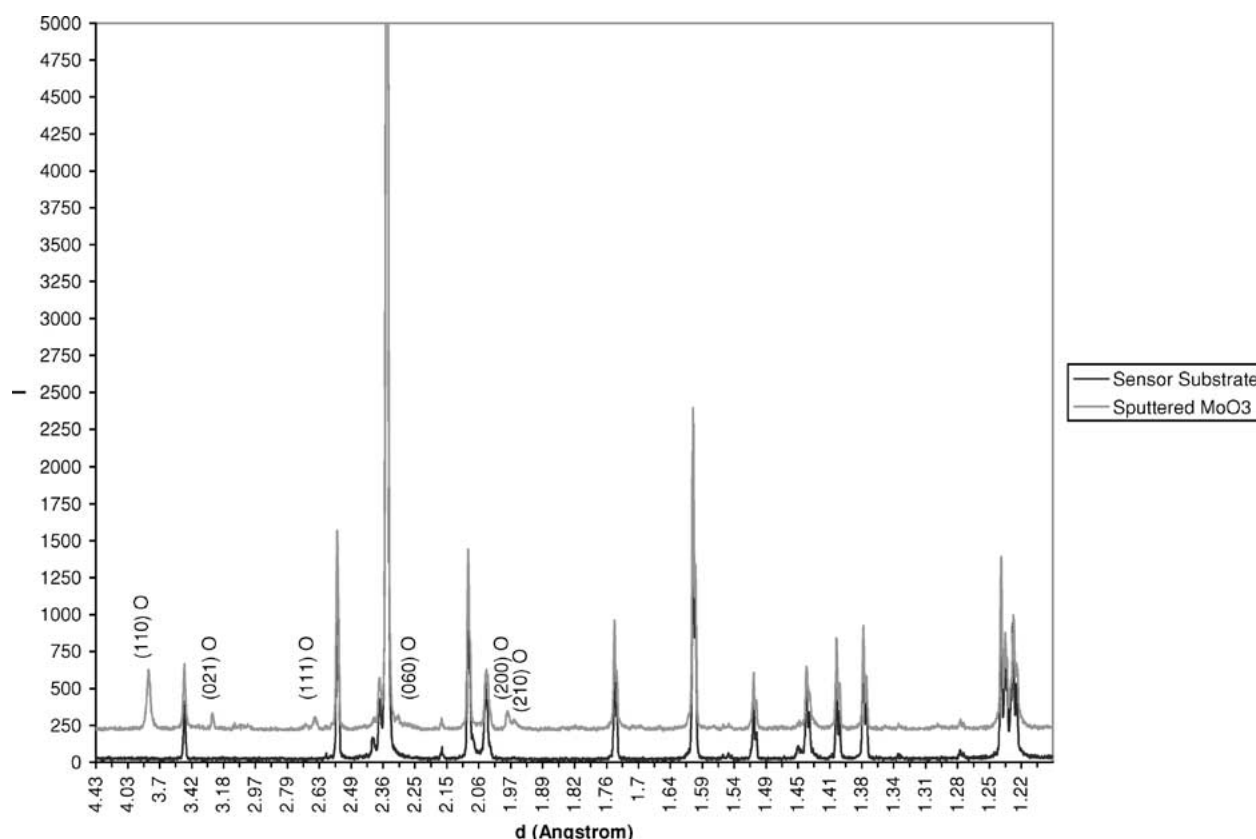


Figure 8 d vs. I graph of ion beam deposited MoO₃ after sensing tests.

distorted structure is stable in several forms giving rise to different phases depending on the temperature; in this case studied the orthorhombic polymorph was stabilized.

Earlier studies by the authors of this paper [21] has shown that when the MoO₃ sensing film consists of both α - and β -polymorphs its sensitivity to ammonia is reduced. This may be explained by the fact that the β -MoO₃ structure is closely related to that of WO₃, which is not sensitive to NH₃. Moreover, a chemical reaction between MoO₃ and ammonia is expected to occur during sensing [23] whereas in the case of WO₃, only adsorption is anticipated to be the underlying sensing mechanism against NO₂. Further investigations are currently under way to elucidate the sensing mechanism for the two oxides relative to the gases examined here.

In summary, it is important to note that the microstructure and crystallographic characteristics of the oxide used for sensing are key parameters controlling the gas sensing response. The discrepancy in the reported sensing properties for the same oxide system (as discussed for MoO₃ and WO₃ above) by several workers is expected to be strongly related to the differences in the (micro-) structural configuration of the sensing elements.

5. Conclusions

Thin films of MoO₃ and WO₃ were prepared by ion beam deposition and subjected to similar annealing conditions of 500°C for 8 h. MoO₃ films are found to be sensitive to ammonia whereas WO₃ films are found to be selective to NO₂. The longer recovery times as

observed in latter films might be attributed to lower gas desorption rate. The importance of the oxide polymorph used for sensing has been discussed in the light of the present and earlier results. Microstructural control of the oxide films is expected to be critical for achieving selectivity in gas sensing.

Acknowledgements

The authors wish to acknowledge the support of Drs. D. Kubinski and J. Visser, Ford R&A, and Prof. Richard Gambino, Magneto-Optics Group MSE dept, SUNY Stony Brook. This project has been supported by NSF award #DMR0224642 with Dr. L. Madsen as the program manager.

References

1. R. MOOS, R. MULLER, C. PLOG, A. KNEZEVIC, H. LEYE, E. IRION, T. BRAUN, K. MARQUARDT and K. BINDER, *Sensor Actuat B-Chem* **83** (2002) 181.
2. B. T. MARQUIS and J. F. VETELINO, *ibid.* **77** (2001) 100.
3. D. MUTSCHALL, K. HOLZNER and E. OBERMEIER, *ibid.* **36** (1996) 320.
4. E. COMINI, G. FAGLIA, G. SBERVEGLIERI, C. CANTALINI, M. PASSACANTANDO, S. SANTUCCI, Y. LI, W. WLODARSKI and W. QU, *ibid.* **68** (2000) 168.
5. C. IMAWAN, F. SOLZBACHER, H. STEFFES and E. OBERMEIER, *ibid.* **64** (2000) 193.
6. M. FERRONI, V. GUIDI, G. MARTINELLI, P. NELLI, M. SACERDOTI and G. SBERVEGLIERI, *Thin Solid Films* **307** (1997) 148.
7. C. IMAWAN, H. STEFFES, F. SOLZBACHER and E. OBERMEIER, *Sensor Actuat B-Chem* **78** (2001) 119.
8. M. FERRONI, D. BOSCARINO, E. COMINI, D. GNANI, V. GUIDI, G. MARTINELLI, P. NELLI, V. RIGATO and G. SBERVEGLIERI, *ibid.* **58** (1999) 289.
9. P. J. SHAVER, *Appl. Phys. Lett.* **11** (1967) 255.

CHEMICAL SENSORS

10. T. MAEKAWA, J. TAMAKI, N. MIURA and N. YAMAZOE, *Chem. Lett.* (1992) 639.
11. M. PENZA, M. A. TAGLIENTE, L. MIRENGHI, C. GERARDI, C. MARTUCCI and G. CASSANO, *Sensor Actuat B-Chem* **50** (1998) 9.
12. G. SBERVEGLIERI, L. DEPERO, S. GROPELLI and P. NELLI, *ibid.* **26** (1995) 89.
13. X. S. WANG, N. MIURA and N. YAMAZOE, *ibid.* **66** (2000) 74.
14. C. N. XU, N. MIURA, Y. ISHIDA, K. MATSUDA and N. YAMAZOE, *ibid.* **65** (2000) 163.
15. E. LLOBET, G. MOLAS, P. MOLINAS, J. CALDERER, X. VILANOVA, J. BREZMES, J. E. SUEIRAS and X. CORREIG, *J. Electrochem. Soc.* **147** (2000) 776.
16. J. TAMAKI, Z. ZHANG, K. FUJIMORI, M. AKIYAMA, T. HARADA, N. MIURA and N. YAMAZOE, *ibid.* **141** (1994) 2207.
17. C. CANTALINI, M. Z. ATASHBAR, Y. LI, M. K. GHANTASALA, S. SANTUCCI, W. WLODARSKI and M. PASSACANTANDO, *J. Vac. Sci. Technol. A* **17** (1999) 1873.
18. C. CANTALINI, W. WLODARSKI, Y. LI, M. PASSACANTANDO, S. SANTUCCI, E. COMINI, G. FAGLIA and G. SBERVEGLIERI, *Sensor Actuat B-Chem* **64** (2000) 182.
19. J. L. SOLIS, S. SAUKKO, L. B. KISH, C. G. GRANQVIST and V. LANTTO, *ibid.* **77** (2001) 316.
20. Y. K. CHUNG, M. H. KIM, W. S. UM, H. S. LEE, J. K. SONG, S. C. CHOI, K. M. YI, M. J. LEE and K. W. CHUNG, *ibid.* **60** (1999) 49.
21. A. K. PRASAD, D. KUBINSKI and P. I. GOUMA, *ibid.* **93** (2003) 25.
22. L. J. LEGORE, R. J. LAD, S. C. MOULZOLF, J. F. VETELINO, B. G. FREDERICK and E. A. KENIK, *Thin Solid Films* **406** (2002) 79.
23. A. K. PRASAD, P. I. GOUMA, D. J. KUBINSKI, J. H. VISSER, R. E. SOLTIS and P. J. SCHMITZ, *ibid.* **436** (2003) 46.

*Received 3 April
and accepted 1 August 2003*